

NCE Automotive N-Channel Super Trench II Power MOSFET

Description

The NCEAP25N10AG uses **Super Trench II** technology that is uniquely optimized to provide the most efficient high frequency switching performance. Both conduction and switching power losses are minimized due to an extremely low combination of $R_{DS(ON)}$ and Q_g . This device is ideal for high-frequency switching and synchronous rectification.

Application

- Automotive application
- DC/DC Converter
- Ideal for high-frequency switching and synchronous rectification

General Features

V_{DS} =100V,I_D =32A

 $R_{DS(ON)}$ =21m Ω (typical) @ V_{GS}=10V

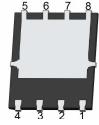
 $R_{\text{DS(ON)}}\text{=}26m\Omega$ (typical) @ $V_{\text{GS}}\text{=}4.5V$

• Excellent gate charge x R_{DS(on)} product(FOM)

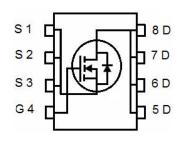
- Very low on-resistance R_{DS(on)}
- 175°C operating temperature
- Pb-free lead plating;RoHScompliant
- Halogen-freeaccordingtoIEC61249-2-21
- 100% UIS tested
- 100% ΔVds tested
- AEC-Q101 qualified

DFN 5X6





Bottom View



Schematic Diagram

Package Marking and Ordering Information

		<u> </u>			
Device Marking	Device	Device Package	Reel Size	Tape width	Quantity
AP25N10AG	NCEAP25N10AG	DFN5X6-8L	Ø330mm	12mm	5000units

Absolute Maximum Ratings (T_c=25℃unless otherwise noted)

Parameter	Symbol	Limit	Unit
Drain-Source Voltage	V _{DS}	100	V
Gate-Source Voltage	V _G s	±20	V
Drain Current-Continuous	I _D	32	Α
Drain Current-Continuous(Tc=100℃)	I _D (100℃)	23	Α
Pulsed Drain Current	I _{DM}	128	Α
Maximum Power Dissipation	P _D	54	W
Derating factor		0.36	W/℃
Single pulse avalanche energy (Note 5)	Eas	97	mJ
Operating Junction and Storage Temperature Range	T_{J}, T_{STG}	-55 To 175	$^{\circ}$

Thermal Characteristic



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NCEAP25N10AG

Thermal Resistance,Junction-to-Case^(Note 2) R_{BJC} 2.78 °C/W

Electrical Characteristics (T_C=25°C unless otherwise noted)

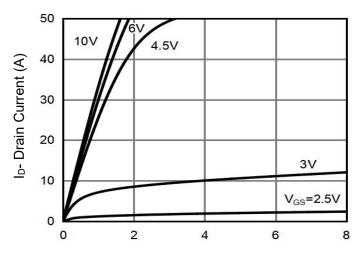
Parameter	Symbol	Condition	Min	Тур	Max	Unit
Off Characteristics			•	'		
Drain-Source Breakdown Voltage	BV _{DSS}	V _{GS} =0V I _D =250µA	100		-	V
Zero Gate Voltage Drain Current	I _{DSS}	V _{DS} =100V,V _{GS} =0V	-	-	1	μΑ
Gate-Body Leakage Current	I _{GSS}	V_{GS} =±20 V , V_{DS} =0 V	-	-	±100	nA
On Characteristics (Note 3)			•			
Gate Threshold Voltage	V _{GS(th)}	$V_{DS}=V_{GS},I_{D}=250\mu A$	1.1	1.7	2.5	V
Prain-Source On-State Resistance	Б	V _{GS} =10V, I _D =15A	-	21	25	mΩ
	R _{DS(ON)}	V _{GS} =4.5V, I _D =15A	-	26	30	mΩ
Forward Transconductance	g FS	V _{DS} =5V,I _D =15A		19	-	S
Dynamic Characteristics (Note4)						
Input Capacitance	C _{lss}	V 50VV 0V	-	1317.6	-	pF
Output Capacitance	Coss	V_{DS} =50V, V_{GS} =0V, F=1.0MHz	-	123.9	-	pF
Reverse Transfer Capacitance	Crss	F=1.UMHZ	-	19.3	-	pF
Switching Characteristics (Note 4)	·					•
Turn-on Delay Time	t _{d(on)}		_	13	-	nS
Turn-on Rise Time	Time t_r $V_{DD}=50V,I_D=15A$	V_{DD} =50 V , I_D =15 A	-	15	-	nS
Turn-Off Delay Time	t _{d(off)}	V_{GS} =10 V , R_{G} =3 Ω	-	22	-	nS
Turn-Off Fall Time	t _f		-	6	-	nS
Total Gate Charge	Qg	\/ F0\/ 45A	-	27.6	-	nC
Gate-Source Charge	Q _{gs}	V _{DS} =50V,I _D =15A,	-	5.5		nC
Gate-Drain Charge	Q _{gd}	V _{GS} =10V	-	6.9		nC
Drain-Source Diode Characteristics						
Diode Forward Voltage (Note 3)	V _{SD}	V _{GS} =0V,I _S =15A	-		1.2	V
Diode Forward Current (Note 2)	Is		-	-	32	Α
Reverse Recovery Time	t _{rr}	T _J = 25°C, I _F = 15A	-	40	-	nS
Reverse Recovery Charge	Qrr $di/dt = 100A/\mu s^{(Note3)}$		-	85	-	nC

Notes:

- 1. Repetitive Rating: Pulse width limited by maximum junction temperature.
- 2. Surface Mounted on FR4 Board, t ≤ 10 sec.
- 3. Pulse Test: Pulse Width \leq 300 μ s, Duty Cycle \leq 2%.
- 4. Guaranteed by design, not subject to production
- 5. EAS condition : Tj=25 $^{\circ}\text{C}$,VDD=50V,VG=10V,L=0.5mH,Rg=25 Ω



Typical Electrical and Thermal Characteristics



Vds Drain-Source Voltage (V)



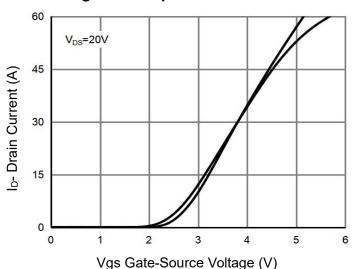


Figure 2 Transfer Characteristics

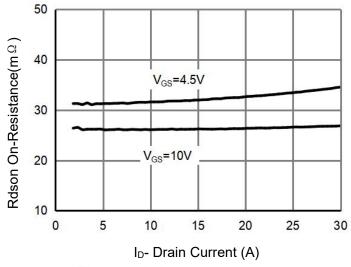


Figure 3 Rdson- Drain Current

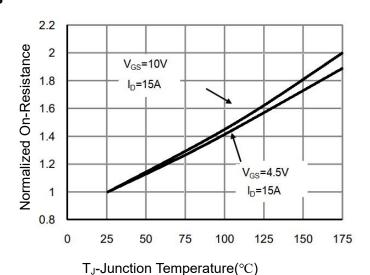


Figure 4 Rdson-Junction Temperature

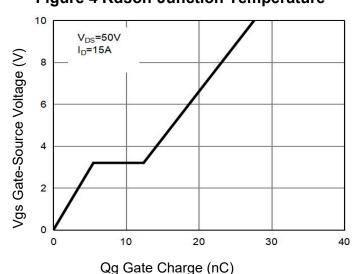


Figure 5 Gate Charge

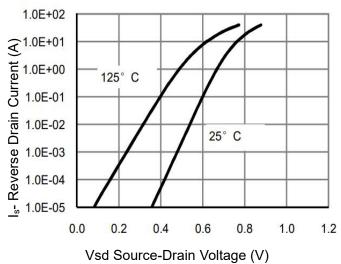
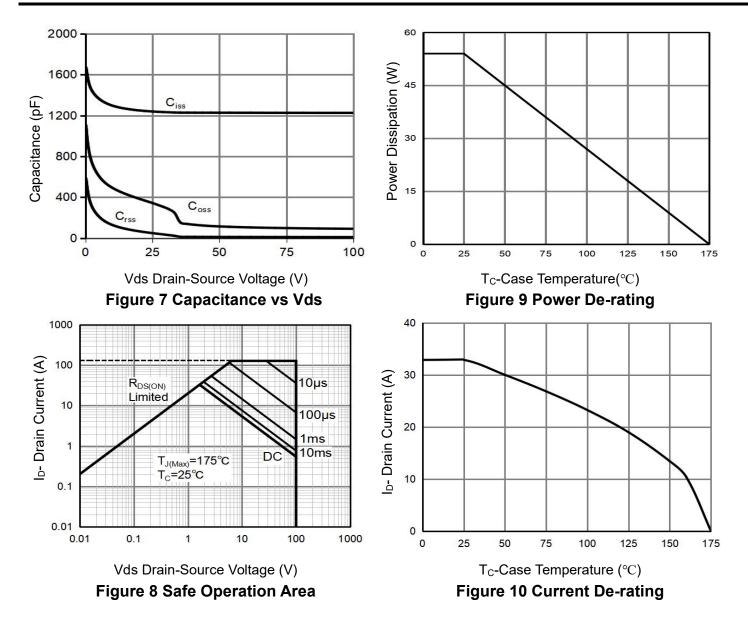


Figure 6 Source- Drain Diode Forward





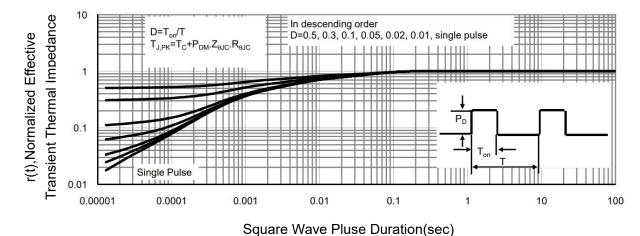
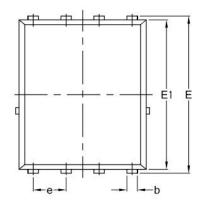
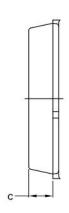


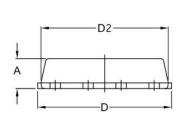
Figure 11 Normalized Maximum Transient Thermal Impedance

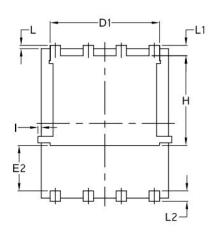


DFN5X6-8L Package Information









	S Y	COMMON				
	M B	MM		INCH		
	O	MIN.	MAX.	MIN.	MAX.	
	Α	1.03	1.17	0.0406	0.0461	
	b	0.34	0.48	0.0134	0.0189	
	С	0.824	0.970	0.0324	0.0382	
A	D	4.80	5.40	0.1890	0.2126	
	D1	4.11	4.31	0.1618	0.1697	
A	D2	4.80	5.00	0.1890	0.1969	
in voital	E	5.95	6.15	0.2343	0.2421	
	E1	5.65	5.85	0.2224	0.2303	
	E2	1.60		0.0630	92	
	е	1.27 BSC		0.05 BSC		
A	L	0.05	0.25	0.0020	0.0098	
	L1	0.38	0.50	0.0150	0.0197	
	L2	0.38	0.50	0.0150	0.0197	
4	Н	3.30	3.50	0.1299	0.1378	
	1	_	0.18	_	0.0070	

NCEAP25N10AG

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